

ABSTRACT OF THE DISCLOSURE

A method for manufacturing a printed circuit board includes:
washing a land that corresponds to the exposed portion of a copper circuit of
5 a printed circuit board with acidic electrolytic water having a pH of not
more than 5 to remove an oxide; treating the land with basic electrolytic
water having a pH of not less than 9 to prevent oxidation; and soldering
electronic components to the land. The portion to be soldered is treated
10 with the electrolytic water beforehand, thereby improving soldering at low
cost without any adverse effect on the environment.